Sisco

53200A Series RF/Universal Frequency Counter/Timers

Imagine Your Counter Doing More!

Introduction

Frequency counters are depended on in R&D and in manufacturing for the fastest, most accurate frequency and time interval measurements. The 53200 Series of RF and universal frequency counter/timers expands on this expectation to provide you with the most information, connectivity and new measurement capabilities, while building on the speed and accuracy you've depended on with SISCO Technologies, Inc. time and frequency measurement expertise.

Three available models offer resolution capabilities up to 12 digits/sec frequency resolution on a one second gate. Single-shot time interval measurements can be resolved down to 20 psec. All models offer new built-in analysis and graphing capabilities to maximize the insight and information you receive.





More bandwidth

- 350 MHz baseband frequency
- 6 or 15 GHz optional microwave channels

More resolution & speed

- 12 digits/sec
- 20 ps single-shot time resolution
- Up to 75,000 and 90,000 readings/sec (frequency and time interval)

More insight

- Datalog trend plot
- Cumulative histogram
- Built-in math analysis and statistics
- 1M reading memory and USB Flash storage

More connectivity

- LXI-C/Ethernet LAN, USB, GPIB
- Optional battery for unstable AC power or timebase accuracy

More measurement capability (53230A only)

- Continuous gap-free measurements
- Basic measurement and timestamps for modulation domain analysis (MDA)
- Pulse/burst microwave measurement



Measurement by model

Measurements	Model	Standard 350 MHz Input Channel(s)	Opt MW Inputs (53210A: Ch 2, 53220A/30A: Ch 3)
Frequency	53210A, 53220A, 53230A	•	•
Frequency ratio	53210A, 53220A, 53230A	•	•
Period	53210A, 53220A, 53230A	٠	•
Minimum/maximum/peak-to-peak input voltage	53210A, 53220A, 53230A	•	
RF signal strength	53210A, 53220A, 53230A		•
Single period	53220A, 53230A	•	
Time interval A to B, B to A, A, B	53220A, 53230A	•	
Positive/negative pulse width	53220A, 53230A	•	
Rise/fall time	53220A, 53230A	•	
Positive/negative duty	53220A, 53230A	•	
Phase A to B, B to A	53220A, 53230A	•	
Totalize (continuous or timed)	53220A, 53230A	•	
Continuous/gap-free	53230A	•	•
Timestamp	53230A	•	•
Pulse/burst measurement software1	53230A		•

^{1.} Burst carrier frequency, pulse repetition frequency (PRF), pulse repetition interval (PRI), burst positive width ("on" time), burst negative width ("off" time).



SISCO BenchVue Software (Now Included)

SISCO BenchVue software for the PC makes it simple to connect, control instruments, and automate test sequences so you can quickly move past the test development phase and access results faster with just a few clicks.

The Universal Counter Control & Automation App within BenchVue is now included with your instrument purchase.

- Access the most commonly used universal counter controls using an intuitive interface.
- Quickly display single measurements, charts, tables, or histograms from a single instrument or multiple counters simultaneously to correlate trends you might otherwise miss
- Conveniently log and export data in only few clicks to popular tools, such as MATLAB and Microsoft Excel or Word for documentation or further analysis
- Rapidly develop custom test procedures or sequences with Test Flow
- Deeper instrument controls with Command Expert integration
- SISCO Care software support subscription included
- License included with new instrument purchase

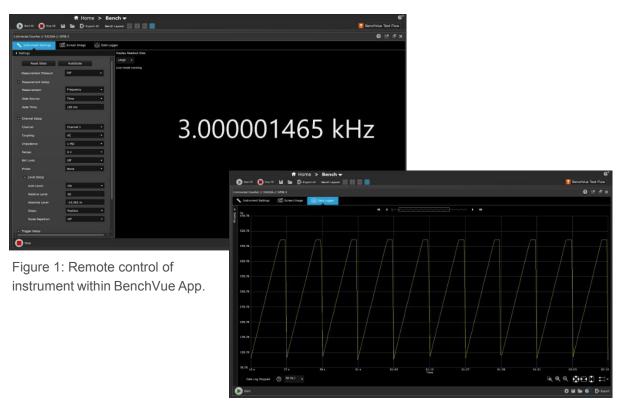


Figure 2: Log Data remotely within BenchVue App.



Input characteristics (nom)	53210A	53220A	53230A	
Input characteristics (nom)	5321UA	532ZUA	5323UA	
Channels				
Standard (DC - 350 MHz)	Ch 1	Ch 1 8	Ch 2	
Optional (6 or 15 GHz)	Ch 2	Ch	13	
Standard inputs (nom)				
Frequency range				
DC coupled	DC (1 m	Hz) to 350 MHz (2.8 ns	to 1000 sec)	
AC coupled, 50 Ω 1 or 1 M Ω		10 Hz - 350 MHz		
Input				
Connector	Front panel BNC(f). Option 201 adds parallel rear panel BNC(f) inputs ²			
Input impedance (typ)	Selectable	1 M Ω ± 1.5% or 50 Ω ±	1.5% <25 pF	
Input coupling	Selectable DC or AC			
Input filter	Selectable 100 kHz cut-off frequency low pass 10 Hz (AC coupling) cut-off frequency high pass filter			
Amplitude range				
Input range	±5 V (±50 V) full scale ranges			
Sensitivity ^{3,4} (typ)	DC - 100 MHz: 20 mVpk > 100 MHz: 40 mVpk			
Noise ³	500) μVrms (max), 350 μVrr	ms (typ)	
Input event thresholds				
Threshold levels	±5 V	(±50 V) in 2.5 mV (25 m	nV) steps	
Noise reject ⁴		Selectable On/ Off		
Slope	S	electable Positive or Ne	gative	
Auto-scale	Acquires signal for current measurement channel, selects range (5 V or 50 V), sets auto-level 50%			
Auto-level	Selectable On or Off On: Sets auto-level (% of Vpp) operation Occurs once for each INIT or after a timeout. Measures signal Vpp and sets Trigger level to 50% Off: Selectable user set level (Volts)			



	53210A	53220A	53230A
Minimum signal frequency for auto level	User sele	ctable (Slow (50 Hz), F	ast (10 kHz))
Minimum signal for auto level		300 mVpp	
Maximum input			
50 Ω damage level		1 W	
$50~\Omega$ protection threshold		ill not activate below 7 nination auto-protects	•
1 M Ω damage level	5 kHz - 100 k	C - 5 kHz: 350 Vpk (AC Hz: Derate linearly to 100 kHz: 10 Vpk (AC	10 Vpk (AC + DC)
Optional microwave inputs (nom)			
Frequency range			
Option 106		100 MHz - 6 GHz	
Option 115		300 MHz - 15 GHz	2
Input			
Connector		ont panel precision Types the input connector t	. ,
Input impedance (typ)		50 Ω ± 1.5% (SWR <	2.5)
Input coupling		AC	
Continuous wave amplitude range			
Option 106	Autora	nged to +19 dBm max	(2 Vrms)
Option 115	Autorar	nged to +13 dBm max.	(1.0 Vrms)
Sensitivity (typ) ⁵	6 GHz	z (Opt 106): -27 dBm (* 15 GHz (Opt 115): < 3 GHz: -23 dBm 3 – 11 GHz: -27 dB > 11 GHz: -21 dBn	: n m
Input event thresholds			
Level range	Auto-ranged	for optimum sensitivit	y and bandwidth
AM tolerance ⁶		50% modulation dep	oth
Maximum input			
Damage level		z (Opt 106): > +27 dBr dz (Opt 115): > +19 dB	,



- 1. AC coupling occurs after 50 Ω termination.
- When ordered with optional rear terminals, the standard/baseband channel inputs are active on both the front and rear of the universal counter though the specifications provided only apply to the rear terminals.
 Performance for the front terminals with rear terminals installed is not specified.
- 3. Multiply value(s) by 10 for the 50 V range.
- 4. Stated specification assumes Noise Reject OFF. Noise Reject ON doubles the sensitivity minimum voltage levels.
- 5. Assumes sine wave.
- 6. CW only. Assumes AM Rate > 10/gate. For Option 106, spec applies for input powers > -20 dBm; use a tolerance of 15% modulation depth for frequencies less than 900 MHz. For Option 115, spec applies for input powers > -10 dBm.

Measurement Characteristics

	53210A	53220A	53230A	
Measurement range (nom)				
Frequency, period (average) measurer	nents			
Common				
Channels	Ch 1 or optional Ch 2	Ch 1, Ch 2 or 0	optional Ch 3	
Digits/s	10 digits/s	12 digits/s	12 digits/s	
Maximum display Resolution ¹	12 digits	15 digits	15 digits	
Measurement technique	Reciprocal	Reciprocal and resolution enhanced	Reciprocal, resolution- enhanced or continuous (gap-free)	
Signal type	Continuous	s Wave (CW)	CW and pulse/burst	
Level & slope	Aut	omatically preset or user selecta	able	
Gate		Internal or external		
Gate time ²	1 ms to 1000 s in 10 μs steps	100 μs to 1000 s in 10 μs steps	1 μs to 1000 s in 1 μs steps	
Advanced gating ³	N/A	Start delay (time or eve (time or		
FM tolerance		± 50%		
Frequency, period				
Range ⁹	DC (1	mHz) to 350 MHz (2.8 ns to 10	00 s)	
Microwave input (optional)	Option 106 - 100 MHz to 6 GHz (166 ps to 10 ns) Option 115 - 300 MHz to 15 GHz (66 ps to 3.3 ns)			
Frequency ratio4				
Range		10 ¹⁵ Displayable range		
Timestamp/modulation domain				
Sample rate ⁵	N/A	N/A	1 MSa/s, 800 kSa/s,	



100 kSa/s, 10 kSa/s

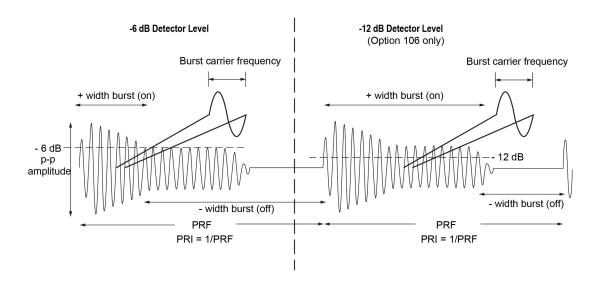
	53210A	53220A	53230A
#Edges/timestamp	N/A	N/A	Auto-acquired per
Acquisition length	N/A	N/A	up to 1 MSa or
Time interval (single-shot) measurements ¹	1		100,000 s (max)
Common			
Channels	N/A		h 1 or 2
Single-shot time resolution	N/A	100 ps	20 ps
Gating	N/A	Start delay (time or	or external gate events) and stop hold-off or events)
Slope	N/A	Independent	t start, stop slopes
Level	N/A	Independent	start, stop slopes
Channel-to-channel time skew (typ)	N/A	100 ps	50 ps
Time interval A to B, B to A			
Range ⁹	N/A	-1 ns to 100,000 s (nom) -0.5 ns to 100,000 s (min)	
Time interval A or B			
Range	N/A	2 ns to 100,000 s (min)	
Minimum width	N/A	2 ns	
Minimum edge repetition rate	N/A		6 ns
Level & slope	N/A	Auto-level o	or user selectable
Single-period, pulse-width, rise time, fall t	ime		
Range	N/A	0 s	to 1000 s
Minimum width	N/A		2 ns
Minimum edge repetition rate	N/A	6 ns	
Level & slope	N/A	Auto-level or user selectable	
Duty			
Range	N/A	.000001 to .999999	or 0.0001% to 99.9999%
Minimum width	N/A		2 ns
Level & slope	N/A	Auto-level o	or user selectable



		53210A	53220A	53230A	
Phase A to B, B to A					
Range ⁶		N/A	-	180.000° to 360.000°	
Totalize measurements					
Channels		N/A		Ch 1 or Ch 2	
Range ⁹		N/A		0 to 10 ¹⁵ events	
Rate		N/A		0 - 350 MHz	
Gating		N/A		s, timed, or external gate input tate accuracy is 20 ns	
Level measurements					
Voltage level - standard input channels		±5.1 Vpl	k with 2.5 mV resolution or ±51	Vpk with 25 mV resolution	
Microwave power level (microwave channel option)			0 to 4 relative signal power		
	53210A	53220A	53230A		
			6 GHz (Option 106)	15 GHz (Option 115)	
Pulse/burst frequency and pulse en	velope detec	tor 12			
Pulse/burst measurements	N/A	N/A	Carrier frequency, carrier period, pulse repetition interval (PRI), pulse repetition frequency (PRF), positive and negative width		
Pulse/burst width for carrier frequency measurements ¹⁰	N/A	N/A	> 200 ns		
Minimum pulse/burst width for envelope measurements	N/A	N/A	> 50 ns	> 100 ns	
Acquisition	N/A	N/A	Αι	ito, Manual ⁷	
PRF, PRI range	N/A	N/A	1 Hz – 10 MHz	1 Hz - 5 MHz	
Pulse detector response time (typ) ⁸	N/A	N/A	15 ns rise/fall	40 ns rise/fall	
Pulse width accuracy	N/A	N/A	20 ns + (2*carrier period)	75 ns	
Power ratio (typ)	N/A	N/A		> 15 dB	
Power range and sensitivity (sinusoidal) (typ)	N/A	N/A	+13 dBm (1 Vrms) to -13 dBm (50 mVrms)	< 3 GHz: +7 dBm (500 mVrms) to -6 dBm (115 mVrms) 3 - 11 GHz: +9 dBm (630 mVrms) to -8 dBm (90 mVrms) > 11 GHz: +7 dBm (500 mVrms) to -6 dBm (115 mVrms)	



- 1. Maximum display resolution for frequency and period. Totalize display resolution is 15 digits, time interval based measurements are 12 digits.
- 2. Continuous, gap-free measurements limits the gate time setting to 10 μs to 1000 s in 10 μs steps.
- 3. Refer to the gate characteristics section for more details on advanced gate capabilities.
- 4. Measurements on each input channel are performed simultaneously using one gate interval. The actual measurement gate interval on each channel will be synchronous with edges of each input signal.
- 5. Maximum sample rate. Actual sample rate will be limited by the input signal edge rate for signals slower than the selected sample rate. Maximum timestamp rate offers minimal FM tolerance. If high FM tolerance is required, use lower timestamp rates.
- 6. Assumes two frequencies are identical, only shifted in phase.
- 7. Manual control of gate width and gate delay are allowed only for wide pulsed mode.
- 8. For pulsed signals > -7 dBm (100 mVrms) while gated on.
- 9. For totalize, time interval and frequency measurements, you may get measurement readings beyond the range stated, but the accuracy of those readings is not specified.
- 10. Applies when burst width * Carrier Freq > 80.
- 11. Specifications apply if measurement channels are in 5 V range, DC coupled, 50 Ω terminated and at fixed level for: time interval single and dual channel, pulse width, duty, phase, single period and rise/fall time measurements.
- 12. Microwave pulse/burst measurement descriptions:



Gate, Trigger and Timebase Characteristics

	53210A	53220A	53230A
Gate characteristics (nom) Gate			
Source	Time, external	Time, external	or advanced
Gate time (step size) 1	1 ms - 1000 s (10 µs)	100 μs - 1000 s (10 μs)	1 µs - 1000 s (1 µs)



	53210A	53220A	53230A	
Advanced: gate start				
Source	N/A	Internal or extern (unused standard		
Slope	N/A	Positive or	negative	
Delay time ¹	N/A	0 s to 10 s in	10 ns steps	
Delay events (edges)	N/A	0 to 10 ⁸ for signals	up to 100 MHz	
Advanced: gate stop hold-off				
Source	N/A	Internal or extern (unused standard		
Slope	N/A	Positive or	negative	
Hold-off time ¹	N/A	Hold-off Time settable	from 60 ns to 1000 s	
Hold-off events (edges)	N/A	0 to 108 (minimum width > 60		
External gate input characteristics (typ)			
Connector	Rear panel BNC(f) Selectable as external gate input or gate output signal			
Impedance	1 kΩ when selected as external gate input			
Level	TTL compatible			
Slope		Selectable positive or negative	/e	
Gate to gate timing		3 µs gate end to next gate sta	art	
Damage level		<-5 V, > +10 V		
Gate output characteristics (typ)				
Connector	Rear panel BNC(f) Selectable as external gate input or gate output signal			
Impedance	5	50 Ω when selected for gate ou	itput	
Level		TTL compatible		
Slope		Selectable positive or negative	/e	
Damage level		< -5 V, > +10 V		



Input Channel Characteristics Trigger and Timebase Characteristics (nom)

	53210A	53220A	53230A		
Trigger characteristics (nom) General					
Trigger source		Internal, external, bus, manu	al		
Trigger count		1 to 1,000,000			
Trigger delay		0 s to 3600 s in 1 μs steps			
Samples/trigger		1 to 1,000,000			
External trigger input (typ)					
Connector		Rear panel BNC(f)			
Impedance		1 kΩ			
Level		TTL compatible			
Slope	Selectable positive or negative				
Pulse width	> 40 ns min				
Latency ²	Frequency, period: 1 µs + 3 periods time interval, totalize: 100 ns				
External trigger rate	300/s max	1 k/s max	10 k/s max		
Damage level		<-5 V, > +10 V			
Timebase characteristics (nom)					
Timebase reference		Internal, external, or auto			
Timebase adjustment method	С	losed-box electronic adjustm	ent		
Timebase adjustment resolution	10 ⁻¹⁰ (10 ⁻¹¹ for Option 010 U-OCXO timebase)				
External timebase input (typ)					
Impedance	1 kΩ AC coupled				
Level (typ)	100 mVrms to 2.5 Vrms				
Lock frequencies	10 MHz, 5 MHz, 1 MHz				
Lock range	±1 ppm (±0.1 ppm for Option 010 U-OCXO timebase)				
Damage level		7 Vrms			



	53210A	53220A	53230A	
Timebase output (typ)				
Impedance		50 Ω ± 5% at 10 MHz		
Level	0.5 Vrms into a 50 Ω load 1.0 Vrms into a 1 kΩ load			
Signal		10 MHz sine wave		
Damage level		7 Vrms		

^{1.} Continuous, gap-free measurements limits the Gate Time setting to 10 μs to 1000 s in 10 μs steps.

Math, Graphing and Memory Characteristics (nom)

	53210A	53220A	53230A		
Math operations					
Smoothing (averaging) ¹	Selectable filter reset .1) (medium), 1,000 (fast) re I % /1000 ppm (fast), .03% ppm (slow) change from a	/300 ppm (medium),		
Scaling	Userso	mX-b or m(1/X)-b ettable m and b (offset) va	lues		
Δ-change	(X-b)/b scaled to %, ppm, or ppb User settable b (reference) value				
Null	(X-b) User settable b (reference) value				
Statistics ¹	Mean, standard Mean, standard deviation, Allan deviation ² , deviation, Max, Min, Peak-to-Peak, count Peak-to-Peak, count				
Limit test ³	Displays PASS/ FAIL message based on user defined Hi/ Lo limit values.				
Operation	Individual and simultaneous operation of smoothing, scaling, statistics, and limit test				
Graphical display selections					
Digits	Numeric result with input level shown				
Trend	Strip chart (measurements vs. readings over time) Selectable screen time				

^{2.} Latency does not include delays due to auto-leveling.



	53210A	53220A	53230A		
Histogram	H	gram of measurements; II/LO limit lines shown ectable bin and block size			
Limit test	Measurement result, t	uning bar-graph, and PA	ASS/FAIL message		
Markers	Available to read	values from trend & history	ogram displays		
Memory					
Data log	Guided setup of # of readings/counts; automatically saves acquisition results to non-volatile memory				
Instrument state	Save & recall user-definable instrument setups				
Power-off	Automatically saved				
Power-on	Selectable power-on to reset (Factory), power-off state or user state				
Volatile reading memory	1 M readings (16 MBytes)				
Non-volatile internal memory	75 Mbytes (up to 5 M readings)				
USB file system	Front-panel connector for USB memory device				
Capability	Store/recall user preferences and instrument states, reading memory, and bit map displays				

Speed Characteristics⁴ (meas)

53210A	53220A	53230A
no timeou	t or 10 ms to 2000 s,	in 1 ms steps
	` ,	() ()
Frequency	, Period, Range, Leve	el: 50 ms (typ)
volatile reading m	emory over I/O bus)	
110		120
200		200
200	4	200
	no timeou Slov Fas Frequency volatile reading months	no timeout or 10 ms to 2000 s, Slow mode (50 Hz): 350 i Fast mode (10 kHz): 10 i Frequency, Period, Range, Leve volatile reading memory over I/O bus)



GPIB 210 220 Optimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11) 160 180 LAN (sockets) 330 350 USB 320 350 Block reading throughput!: readings/s (Example uses: 50,000 readings) (time to take blocks of measurements and transfer frow volatile reading word voer I/O bus) TO Propose I/O				
Coptimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11)		53210A	53220A	53230A
LAN (VXI-11)	GPIB	210	22	20
LAN (sockets) 330 350 USB 320 350 GPIB 360 420 Block reading throughputs: readings/s (Example uses: 50,000 readings) (time to take blocks of measurements and transfer from volatile reading memory over I/O bus) Typical (Avg. using READ?): LAN (VXI-11) 300 990 8700 LAN (sockets) 300 990 9700 USB 300 990 9800 GPIB 300 990 9800 GPIB 300 990 34700 LAN (sockets) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 USB 300 990 16300 USB 300 990 16300 USB 300 990 16300 USB 300 990 56500 USB 300 990 16300 User interface and help languages English, German, French, Japanese, Simplified Chinese, Korean languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/100/1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	Optimized (Avg. using *TR0	G;DATA:REM? 1, WAIT):		
USB	LAN (VXI-11)	160	1	80
Block reading throughputs readings/s (Example uses: 50,000 readings) (time to take blocks of measurements and transfer from volatile reading memory over I/O bus) Typical (Avg. using READ?): LAN (VXI-11) 300 990 8700 LAN (sockets) 300 990 9700 USB 300 990 9800 GPIB 300 990 4600 Optimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 55800 USB 300 990 16300 Waximum measurement speed to internal non-volatile memory*: (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.2 protocol)	LAN (sockets)	330	3:	50
Block reading throughputs: readings/s (Example uses: 50,000 readings) (time to take blocks of measurements and transfer from volatile reading memory over I/O bus) Typical (Avg. using READ?): LAN (VXI-11) 300 990 8700 LAN (sockets) 300 990 9800 GPIB 300 990 4600 Optimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 Waximum measurement speed to internal non-volatile memory*: (readings/s) Timestamp N/A N/A 1,000,000 Maximum measurement speed to internal non-volatile memory*: (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/100/1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	USB	320	3:	50
(time to take blocks of measurements and transfer from volatile reading memory over I/O bus) Typical (Avg. using READ?):	GPIB	360	4:	20
LAN (VXI-11) 300 990 8700 LAN (sockets) 300 990 9700 USB 300 990 9800 GPIB 300 990 4600 Optimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory*: (readings/s) Timestamp N/A N/A 1,000,000 User interface and help English, German, French, Japanese, Simplified Chinese, Korean languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)			emory over I/O bus)	
LAN (sockets) 300 990 9700 USB 300 990 9800 GPIB 300 990 4600 Optimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory*: (readings/s) Timestamp N/A N/A 1,000,000 User interface and help anguages English, German, French, Japanese, Simplified Chinese, Korean languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/100/1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol)	Typical (Avg. using READ?):		
USB	LAN (VXI-11)	300	990	8700
GPIB 300 990 4600 Optimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory ⁶ : (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages English, German, French, Japanese, Simplified Chinese, Korean languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2, protocol)	LAN (sockets)	300	990	9700
Optimized (Avg. using *TRG;DATA:REM? 1, WAIT): LAN (VXI-11) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory*: (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages English, German, French, Japanese, Simplified Chinese, Korean languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2, protocol)	USB	300	990	9800
LAN (VXI-11) 300 990 34700 LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory ⁶ : (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages English, German, French, Japanese, Simplified Chinese, Korean languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB (IEEE-488.1, IEEE-488.2 protocol)	GPIB	300	990	4600
LAN (sockets) 300 990 55800 USB 300 990 56500 GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory ⁶ : (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages English, German, French, Japanese, Simplified Chinese, Korean languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	Optimized (Avg. using *TR0	G;DATA:REM? 1, WAIT):		
USB 300 990 56500 GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory ⁶ : (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	LAN (VXI-11)	300	990	34700
GPIB 300 990 16300 Maximum measurement speed to internal non-volatile memory ⁶ : (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	LAN (sockets)	300	990	55800
Maximum measurement speed to internal non-volatile memory ⁶ : (readings/s) Timestamp N/A N/A 1,000,000 User interface and help languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	USB	300	990	56500
Timestamp N/A N/A 1,000,000 User interface and help languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/100/1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	GPIB	300	990	16300
User interface and help languages USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	Maximum measurement speed	to internal non-volatile memory6: (readings/	(s)	
USB flash drive FAT, FAT32 Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	Timestamp	N/A	N/A	1,000,000
Programming language SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	-	English, German, French, Japan	ese, Simplified Ch	inese, Korean
SCPI 532xx Series and 53131A/53132A/53181A Series compatibility mode Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	USB flash drive	FAT, I	FAT32	
Programming interface LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	Programming language			
LXI-C 1.3 10/ 100/ 1000 LAN (LAN Sockets and VXI-11 protocol) USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	SCPI	532xx Series and 53131A/53132A/	53181A Series co	mpatibility mode
USB 2.0 device port USB 2.0 (USB-TMC488 protocol) GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	Programming interface			
GPIB interface GPIB (IEEE-488.1, IEEE-488.2 protocol)	LXI-C 1.3	10/ 100/ 1000 LAN (LAN So	ockets and VXI-11	protocol)
, , , , , , , , , , , , , , , , , , , ,	USB 2.0 device port	USB 2.0 (USB-T	MC488 protocol)	
Web user interface LXI Class C Compatible	GPIB interface	GPIB (IEEE-488.1, IEEE-488.2 protocol)		
	Web user interface	LXI Class C	Compatible	



Operating time (typ)

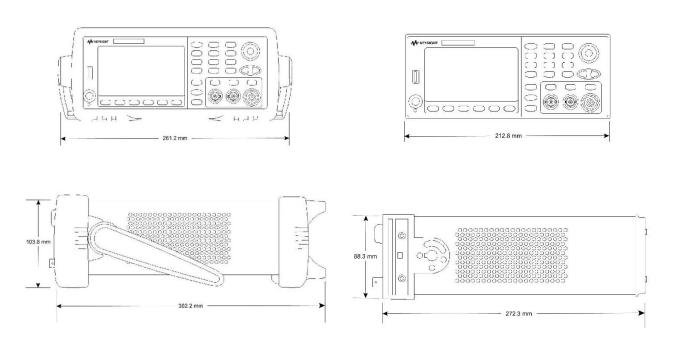
	53210A	53220A	53230A
Mechanical			
Bench dimensions	261.1 mi	m W x 103.8 mm H x 303.2	2 mm D
Rack mount dimensions	212.8 mm W x 8	38.3 mm H x 272.3 mm D ((2U x 1/2 width)
Weight		9 kg (8.6 lbs) fully optioned s) without Option 300 (bat	
Environmental			
Storage temperature		- 30 °C to +70 °C	
Operating environment	EN61010,	pollution degree 2; indoor	locations
Operating temperature		0 °C to +55 °C	
Operating humidity	5%	to 80% RH, non-condensir	ng
Operating altitude	Up	to 3000 meters or 10,000	ft
Regulatory			
Safety & EMC	Refer to Declaration of Conformity for the latest revisions of regulatory compliance at: www.SISCO.com		
Acoustic noise (nom)	SPL 35 dB(A)		
Line power			
Voltage	100V - 240V ± 10%	, 50-60 Hz ±5%100 V - 120	0 V, 400 Hz ±10%
Power consumption	90 VA max when powered on or charging battery 6 VA max when powered off/standby		
Battery (Option 300)			
Technology		ry with integrated smart bar nebase accuracy or enviro AC power	,
Operating temperature limits	Instrument running on b	Battery will only charge ur attery power above 50 °C attery capacity degradation	will turn off to minimize
	53210A	53220A	53230A
Storage temperature limits	Extended exposure to t	-10 °C to 60 °C emperatures above 45 °C performance and life	could degrade battery

3 hours when operated below +35 $^{\circ}\text{C}$



Input Channel Characteristics	24 hours
Standby time - OCXO powered (typ)	
Recharge time (typ) 1	4 hours to 100% capacity; 2 hours to 90% capacity
Accessories included	
Cables	Power line cord, 2 m USB 2.0

1. Assumes calibrated battery.



Dimensions apply to all three models: 53210A, 53220A, 53230A.



Input Channel Characteristics Timebase

Timebase Uncertainty = (Aging + Temperature + Calibration Uncertainty)

Timebase	Standard TCXO	Option 010 Ultra-High Stability OCXO
Aging ¹ (spec)		
24-hour, T _{CAL} ±1 °C		± 0.3 ppb (typ)
30-day, T _{CAL} ±5 °C	± 0.2 ppm (typ)	± 10 ppb
1-year, T _{CAL} ±5 °C	± 1 ppm	± 50 ppb
2-year, T _{CAL} ±5 °C	± 0.5 ppm	± 25 ppb
Temperature (typ) ²		
0 °C to Tcal - 5 °C and Tcal + 5 °C to 55 °C	± 1 ppm	± 5 ppb
Calibration uncertainty ³		
Initial factory calibration (typ)	± 0.5 ppm	± 50 ppb
Settability error	± 0.1 ppb	± 0.01 ppb
Supplemental characteristics (typ)		
5-min. warm-up error ⁴	± 1 ppm	± 10 ppb
72-hour retrace error ⁵	< 50 ppb	< 2 ppb
Allan deviation τ = 1s	1 ppb	0.01 ppb

- 1. All Timebase Aging Errors apply only after an initial 30-days of continuous powered operation and for a constant altitude ±100 m. After the first 1-year of operation, use ½ x (30-day and 1-year) aging rates shown.
- 2. Additional temperature error is included in the time base uncertainty equation if the temperature of the operating environment is outside the TCAL \pm 5 °C (calibration temperature) range. The error is applied in its entirety, not per °C.
- 3. Initial factory calibration error applies to the original instrument calibration upon receipt from the factory. This error is applied until the first re-calibration occurs after shipment. Settability error is the minimum adjustment increment (resolution) achievable during electronic adjustment (calibration) of the instrument. It is added to the uncertainty of your calibration source.
- 4. Warm-up error applies when the instrument is powered on in a stable operating environment.
- 5. When moved between different operating environments add the Temperature error during the initial 30-minutes of powered operation
- 6. Retrace error may occur whenever the instrument line-power is removed or whenever the instrument is battery operated and the battery fully discharges. Retrace error is the residual timebase shift that remains 72-hours after powering-on an instrument that has experienced a full power-cycle of the timebase. Additional frequency shift errors may occur for instrument exposure to severe impact shocks > 50 g.







Front/rear view of 53230A

Accuracy Specifications

Definitions

Random Uncertainty

The RSS of all random or Type-A measurement errors expressed as the total RMS or 1- σ measurement uncertainty. Random uncertainty will reduce as $1/\sqrt{N}$ when averaging N measurement results for up to a maximum of approximately 13-digits or 100 fs.

Systematic Uncertainty

The 95% confidence residual constant or Type-B measurement uncertainty relative to an external calibration reference. Generally, systematic uncertainties can be minimized or removed for a fixed instrument setup by performing relative measurements to eliminate the systematic components.

Timebase Uncertainty

The 95% confidence systematic uncertainty contribution from the selected timebase reference. Use the appropriate uncertainty for the installed timebase or when using an external frequency reference substitute, the specified uncertainty for your external frequency reference.

Basic accuracy 1 = \pm [(k * Random Uncertainty) + Systematic Uncertainty + Timebase Uncertainty]

Measurement Function	1-σ Random Uncertainty	Systematic Uncertainty	Timebase Uncertainty ²
Frequency ³ Period (parts error)	$\frac{1.4^* (T_{SS}^2 + T_E^2)^{1/2}}{R_E^* \text{ gate}}$	If $R_E \ge 2$: 10 ps / gate (max), 2 ps / gate (typ) ⁴ If $R_E < 2$ or REC mode ($R_E = 1$): 100 ps / gate	•
Option 106 & 115: Frequency ³ Period (parts error)	$\frac{1.4^* (T_{SS}^2 + T_E^2)^{1/2}}{R_E^* \text{ gate}}$	If $R_E \ge 2$: 10 ps / gate (max), 2 ps / gate (typ) ⁴ If $R_E < 2$: 100 ps / gate	•
Frequency Ratio A/B (typ) ⁵ (parts error)	1.4* Random Uncertainty of the worst case Freq input	Uncertainty of Frequency A plus Uncertainty of Frequency B	



Measurement Function	1-σ Random Uncertainty	Systematic Uncertainty	
Single Period (parts error) ¹⁷	$\frac{1.4* (T_{SS}^2 + T_{E}^2)^{1/2}}{\text{Period Measurement}}$	T _{accuracy} Period Measurement	٠
Time Interval (TI) ¹⁷ , Width ¹⁷ , or Rise/Fall Time ^{7, 17} (parts error)	1.4* (T _{SS} ² + T _E ²) ^{1/2} TI Measurement	$\frac{\text{Linearity }^{6} + \text{Offset }^{8}}{ \text{TI Measurement} }$ $\text{Linearity} = \text{T}_{\text{accuracy}}$ $\text{Offset (typ)} = \text{T}_{\text{LTE}} + \text{skew} + \text{T}_{\text{accuracy}}$	
Duty 5, 9, 10, 17 (fraction of cycle error)	$2* (T_{SS}^2 + T_{E}^2)^{1/2} * Frequency$	(T _{LTE} + 2*T _{accuracy})*Frequency	
Phase ^{5, 9, 17} (Degrees error)	$2* (T_{SS}^2 + T_E^2)^{1/2} * Frequency * 360°$	(T _{LTE} +skew+2*T _{accuracy})*Frequency*360°	
Totalize ¹¹ (counts error)	± 1 count ¹¹		
Volts pk to pk ¹² (typ) 5 V range		DC, 100 Hz - 1 kHz: 0.15% of reading + 0.15% of range 1 kHz - 1 MHz: 2% of reading + 1% of range 1 MHz - 200 MHz: 5% of reading + 1% of range + 0.3 * (Freq/250 MHz) * reading	
6 GHz (Option 106): Pulse/	/Burst Measurements ^{3, 13}		
PRF, PRI (parts error) 14	If $R_E > 1$: 200 ps / ($R_E * gate$) If $R_E = 1$: 500 ps / gate	200 ps R _E * gate	٠
Pulse/Burst Carrier Frequency ¹⁵ (Narrow Mode) (parts error)	100 ps Burst Width	200 ps Burst Width	
Pulse/Burst Carrier Frequency ¹⁶ (Wide Mode) (parts error)	40 ps R _E * Burst Width	100 ps • R _E * Burst Width	
15 GHz (Option 115): Pulse	e/Burst Measurements ^{3, 13}		
PRF, PRI (parts error) ¹⁴	1 ns (R _E * gate)	200 ps R _E * gate	•
Pulse/Burst Carrier Frequency ¹⁵ (Narrow Mode) (parts error)	100 ps Burst Width	400 ps Burst Width	٠
Pulse/Burst Carrier Frequency ¹⁶ (Wide Mode) (parts error)	75 ps R _F * Burst Width	200 ps • R _E * Burst Width	

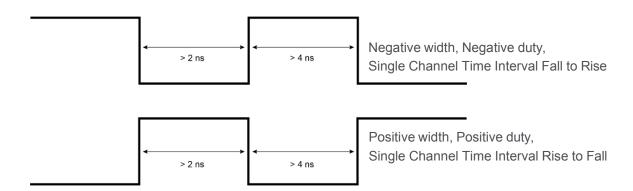
- 1. Apply the appropriate errors detailed for each measuring function.
- 2. Use Timebase Uncertainty in Basic Accuracy calculations only for Measurement Functions that show the symbol in the Timebase
- 3. Uncertainty column.
- 4. Assumes Gaussian noise distribution and non-synchronous gate, non-gaussian noise will affect Systematic Error. Note all optional
- 5. microwave channel specifications (continuous wave and pulse/burst) assume sine signal.
- 6. Typical is achieved with an average of 100 readings with 100 samples per trigger. Worst case is trigger and sample count set to 1.



- 9. Improved frequency ratio, duty and phase specifications are possible by making independent measurements. Minimum Pulse Width for using stated linearity is 5 Neila Stewart. Pulse Widths of 2-5 ns use linearity=400 ps. Residual instrument Rise/ Fall Time 10%-90% 2.0 ns (typ). Applies to fixed level triggering. Threshold can still be set based on % of auto-level detected peaks, but since these peak levels may contain unknown variations, accurate measurements need to be based on absolute threshold levels.
- 10. Input signal slew rates and settling time have effects on offset. Offset is calibrated with rise times < 100 ps.
- 11. Constant Duty or Phase are required during the measurement interval. Duty and Phase are calculated based on two automated sequential measurements period and width or TI A to B, respectively.
- 12. Duty is represented as a ratio (not as a percent).
- 13. Additional count errors need to be added for gated totalize error, latency or jitter. If gated, add gate accuracy term (See Totalize measurements in the Measurement Characteristics section).
- 14. Volts pk error apply for signal levels between full range and 1/10th range. Spec applies to sine wave only. 50 V range reading accuracy is 2% at DC-1 KHz, 5% 1 KHz -1 MHz band. Accuracy above 200 MHz is not specified on both ranges.
- 15. For 6 GHz (Opt 106): Specifications apply to signals from ±13 dBm, operable to ±19 dBm. For 15 GHz (Opt 115): Specifications apply to input powers as listed under "Pulse/burst frequency and pulse envelope detector measurement characteristics", operable from +13 dBm to -8 dBm.
- 16. Use the RE equation, but use the input PRF for FIN. Assume sharp envelope transition.
- 17. Applies when Burst Width * Carrier Freq > 80.
- 18. Specifications based on gate and width for automated detection. If in manual mode, delay and width selected will impact accuracy specification. For approximate accuracy for manual gate, use the RE calculation, but FIN is now 106 and use gate as burst width. For input signals where PRI < 250 μs, double the 1-σ Random Uncertainty specification, unless a Trigger Count of 1 and a large Sample Count acquisition method are used.</p>
 - 19. Specifications apply if measurement channels are in 5 V range, DC coupled, 50Ω terminated and at fixed level. The following minimum pulse width requirements apply:

Single-Period: < 250 MHz, 50% Duty

Phase, Dual Channel Time Interval: < 160 MHz, 50% Duty



Definition of Measurement Error Sources and Terms used in Calculations

	53210A	53220A	53230A
RE	1	use R _E equation	use R _E equation
Tss	100 ps	100 ps	20 ps
Skew		100 ps	50 ps
Taccuracy		200 ps	100 ps



Confidence Level (k)

For 99% Confidence use k= 2.5 in accuracy calculations.

For 95% Confidence use k= 2.0 in accuracy calculations.

Resolution enhancement factor (RE)

The resolution enhancement (R_E) calculates the added frequency resolution beyond the basic reciprocal measurement capability that is achieved for a range of input signal frequencies and measurement gate times. The maximum enhancement factor shown is for input signals where $T_{SS} > T_E$ and is limited due to intrinsic measurement limitations. For signals where $T_{SS} < T_E$, R_E may be significantly higher than the specified levels. R_E will always be ≥ 1 .

For signals where $T_{SS} >> T_E$, $R_E = \sqrt{(F_{IN} * Gate/16)}$ R_E is limited by gate time as show below Gate time > 1 s, R_E max of 6 Gate time 100 ms, R_E max of 4 Gate time 10 ms, R_E max of 2 Gate time < 1 ms, R_E = 1

Interpolation between listed gate times allowed.

Single shot timing (Tss)

Timing resolution of a start/stop measurement event.

Skew

Skew is the additional time error if two channels are used for a measurement. It is not used for width, rise/fall time, and single channel time interval.

Taccuracy

T_{accuracy} is the measurement error between two points in time.

Threshold error (TE)

Threshold error (T_E) describes the input signal dependent random trigger uncertainty or jitter. The total RMS noise voltage divided by the input signal slew rate (V/s) at the trigger point gives the RMS time error for each threshold crossing. For simplicity T_E used in the Random Uncertainty calculations is the worst T_E of all the edges used in the measurement. RSS of all edge's T_E is an acceptable alternative. Vx is the cross talk from the other standard input channel. Typically, this is -60 dB. Vx = 0 on 53210A, and when no signal is applied to other standard input channel on 53220A/53230A. (Note: the best way to eliminate cross talk is to remove the signal from the other channel).

For 5v $(500\mu V^2 + E_N^2 + V_{X2})^{1/2}$ For 50v $(5000\mu V^2 + E_N^2 + V_{X2})^{1/2}$ SR-trig point



Threshold level timing error (T_{LTE})

This time interval error results from trigger level setting errors and input hysteresis effects on the actual start and stop trigger points and results in a combined time interval error. These errors are dependent on the input signal slew rate at each trigger point.

 V_H = 20 mV hysteresis or 40 mV when Noise Reject is turned ON. Double V_H values for frequencies > 100 MHz.

Phase Noise and Allan Deviation

The input signal's jitter spectrum (Phase noise) and low-frequency wander characteristics (Allan variation) will limit the achievable measurement resolution and accuracy. The full accuracy and resolution of the counter can only be achieved when using a high-quality input signal source or by externally filtering the input signal to reduce these errors.

Threshold level setting error (TLSE)

Threshold level setting error (T_{LSE}) is the uncertainty in the actual signal threshold point due to the inaccuracies of the threshold circuitry.

 \pm (0.2%-of setting + 0.1%-of range)

Slew rate (SR)

Slew rate (SR) describes the input signal's instantaneous voltage rate of change (V/s) at the chosen threshold point at customer BNC.

For sine wave signals, the maximum slew rate SR= $2\pi F^*V_{0 \text{ to PK}}$.

For Square waves and pulses, the max slew rate = $0.8 \text{ Vpp/} t_{\text{RISE } 10-90}$

Using the 100 kHz low pass filter will affect Slew Rate.

V/s (at threshold point)

Signal noise (E_N)

The input signal RMS noise voltage (E_N) measured in a DC - 350 MHz bandwidth. The input signal noise voltage is RSS combined with the instruments equivalent input noise voltage when used in the Threshold Error (T_E) calculation.



Input Channel Characteristics Ordering Information

Model numbers

53210A 350 MHz, 10-digits/s RF Frequency Counter 53220A 350 MHz, 12 digits/s, 100 ps Universal Frequency Counter/Timer 53230A 350 MHz, 12-digits/s, 20 ps Universal Frequency Counter/Timer

All models include:

• IEC Power Cord, USB cable

Available options

Option 010	Ultra-high-stability OCXO timebase
Option 106	6 GHz microwave input
Option 115	15 GHz microwave input
Option 201	Add rear panel parallel inputs for baseband channels ¹
Option 202	Optional microwave input - front Type N (default if 106 or 115 ordered)
Option 203	Optional microwave input - rear panel SMA(f) connector
Option 300	Add internal lithium ion smart battery and charger for unstable AC power or timebase stability

Recommended accessories²

1250-1476	BNC(f) to type-N adapter
N2870A	Passive probe, 1:1, 35 MHz, 1.3 m
N2873A	Passive probe, 10:1, 500 MHz, 1.3 m
N2874A	Passive probe, 10:1, 1.5 GHz, 1.3 m
34190A	Rack mount kit; Use for mounting one 2U instrument by itself, without another instrument
	laterally next to it. Includes one rack flange and one combination rack flange-filler panel.
34191A	2U dual flange kit; Use for mounting two 2U instruments side-by-side. Includes two
	standard rack flanges. Note: Mounting two instruments side-by-side will require the
	34194A Dual-lock link kit and a shelf for the instruments to sit on. 34194A Dual-lock link
	kit; for side-by-side combinations of instruments and includes links for instruments of
	different depths.
34131A	Transit case

Support options

- 3-year Annual calibration service
- 5-year Annual calibration service

^{1.} When ordered with optional rear terminals, the standard/baseband channel inputs are active on both the front and rear of the universal counter though the specifications provided only apply to the rear terminals. Performance for the front terminals with rear terminal options is not specified.



2. All probes must be compatible with a 20 pf input capacitance.

Input Channel Characteristics Appendix A - Worked Example

Basic Accuracy Calculation for Frequency Measurement

Parameter assumptions:

- 53220A
- 95% confidence
- 100 MHz signal, 1 sec gate
- AUTO frequency mode
- Level: 5 V input signal amplitude
- TCXO standard timebase for unit plugged in for 30 days
- Assume operating temperature is within T_{CAL} ± 5 °C
- Instrument has been re-calibrated, so Factory Calibration Uncertainty term is not required.

Process:

Basic accuracy = ± [(k * Random Uncertainty) + Systematic Uncertainty + Timebase Uncertainty]

- 2. Random uncertainty for frequency measurement =

$$\frac{1.4^* (T_{SS}^2 + T_{E}^2)^{1/2}}{R_{E}^* \text{ Gate Time}} = \frac{1.4^* (100ps^2 + .159ps^2)^{1/2}}{6^* 1 \text{ s}} = 23.3 \text{ E-12}$$
parts error

$$T_{SS} = 100 \text{ ps}$$
 = $\frac{(500 \text{ }\mu\text{V}^2 + \text{E}_{\text{N}}^2 + \text{V}x^2)^{1/2}}{\text{SR-TRIG POINT}} = \frac{(500 \text{ }\mu\text{V}^2)^{1/2}}{3.14 \text{ }^*10^9} = .159 \text{ ps}$

 E_N = Assume input signal RMS noise voltage is 0.

Vx = N/A (remove signal from other channel)

SR-TRIG POINT = maximum slew rate (sine)SR= $2\pi F^*V_{0 \text{ to PK}}$ = $2\pi (100 \text{ MHz})^*5 \text{ V}$ = $3.14^*109 \text{ Volts/Hz}$ Since Tss >> Te, we use the Re equation. Value is much greater than 6. So we limit Re to 6 due to gate time. Re = 6

Gate time = 1 sec

3. Systematic uncertainty for frequency measurement =

If
$$R_E >= 2$$
: 10 ps/gate max, 2 ps/gate (typ) = $2 E-12$ parts error

4. Timebase uncertainty = aging = 0.2 ppm = 0.2 E-6 parts error



Basic accuracy = \pm [(k * random uncertainty) + systematic uncertainty + timebase uncertainty] = \pm [(2 * (23.3 E-12)) + 2 E-12 + 0.2 E-6] = \pm 0.2 E-6 parts error

Note: Using a higher accuracy timebase or locking to an external timebase standard will have the biggest impact on improvement to accuracy calculations.

Definitions

The following definitions apply to the specifications and characteristics described throughout.

Specification (spec)

The warranted performance of a calibrated instrument that has been stored for a minimum of $2\frac{1}{2}$ hours within the operating temperature range of 0 °C - 55 °C and after a 45-minute warm up period. Automated calibration (*CAL?) performed within ± 5 °C before measurement. All specifications were created in compliance with ISO-17025 methods.

Data published in this document are specifications unless otherwise noted.

Typical (typ)

The characteristic performance, which 80% or more of manufactured instruments will meet. This data is not warranted, does not include measurement uncertainty, and is valid only at room temperature (approximately 23 °C). Automated calibration (*CAL?) performed within ±5 °C before measurement.

Nominal (nom)

The mean or average characteristic performance, or the value of an attribute that is determined by design such as a connector type, physical dimension, or operating speed. This data is not warranted and is measured at room temperature (approximately 23 °C). Automated calibration (*CAL?) performed within ±5 °C before measurement.

Measured (meas)

An attribute measured during development for purposes of communicating the expected performance.

This data is not warranted and is measured at room temperature (approximately 23°C). Automated calibration (*CAL?) performed within ±5 °C before measurement.